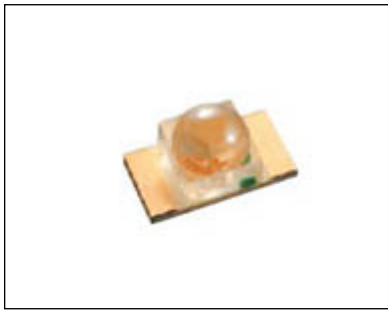




Pb-free
HEAT

STANLEY

1105W Series

Single Color High Brightness Type

Features

Package	3216 Dome Lens Type, Water Clear resin										
Product features	• Outer Dimension 3.2 x 1.6 x 1.85mm (L x W x H) • Temperature range Storage Temperature : -40°C~120°C Operating Temperature : -40°C~100°C • Lead-free soldering compatible • RoHS compliant										
Dominant wavelength	<table><tr><td>Green</td><td>: 562nm(YBG)</td></tr><tr><td>Yellow Green</td><td>: 572nm(YPY)</td></tr><tr><td>Yellow</td><td>: 590nm(FY)</td></tr><tr><td>Orange</td><td>: 605nm(FA)</td></tr><tr><td>Red</td><td>: 626nm(FR)</td></tr></table>	Green	: 562nm(YBG)	Yellow Green	: 572nm(YPY)	Yellow	: 590nm(FY)	Orange	: 605nm(FA)	Red	: 626nm(FR)
Green	: 562nm(YBG)										
Yellow Green	: 572nm(YPY)										
Yellow	: 590nm(FY)										
Orange	: 605nm(FA)										
Red	: 626nm(FR)										
Half Intensity Angle	<table><tr><td>YBG</td><td>: 40 deg.</td></tr><tr><td>YPY,FY,FA,FR</td><td>: 50 deg.</td></tr></table>	YBG	: 40 deg.	YPY,FY,FA,FR	: 50 deg.						
YBG	: 40 deg.										
YPY,FY,FA,FR	: 50 deg.										
Die materials	YBG,YPY,FY,FA,FR : AlGaInP										
Rank grouping parameter	Sorted by luminous intensity per rank taping										
Assembly method	Auto pick & place machine (Auto Mounter)										
Soldering methods	Reflow soldering and manual soldering										
Taping and reel	2,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: ϕ 180mm										
ESD	AlGaInP : More than 2kV(HBM)										

Recommended Applications

Amusement Equipment, Electric Household Appliances, OA/FA, Other General Applications



1105W Series

Single Color High Brightness Type

Color and Luminous Intensity

(Ta=25°C)

Part No.	Material	Emitted Color	Lens Color	Dominant Wavelength λ_d (nm)		Luminous Intensity I_v (mcd)		
				TYP.	I_F	MIN.	TYP.	I_F
YBG1105W	AlGaInP	Green	Water Clear	562	20	25	70	20
YPY1105W	AlGaInP	Yellow Green		572	20	80	220	20
FY1105W	AlGaInP	Yellow		590	20	70	180	20
FA1105W	AlGaInP	Orange		605	20	70	200	20
FR1105W	AlGaInP	Red		626	20	70	180	20

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings					Unit
		YBG	YPY	FY	FA	FR	
Power Dissipation	P_d	78	75	81	81	81	mW
Forward Current	I_F	30	30	30	30	30	mA
Pulse Forward Current ※1	I_{FRM}	100	60	100	100	100	mA
Derating (Ta=75°C or higher)	ΔI_F	1.00	1.00	1.00	1.00	1.00	mA/°C
	ΔI_{FRM}	3.33	2.00	3.33	3.33	3.33	mA/°C
Reverse Voltage	V_R	5	5	5	5	5	V
Operating Temperature	T_{opr}	-40~+100					°C
Storage Temperature	T_{stg}	-40~+120					°C

※1 I_{FRM} Measurement condition : Pulse Width $\leq 1\text{ms.}$, Duty $\leq 1/20$. (FY,FA,FR : Duty $\leq 1/10$)

Electro-Optical Characteristics (YBG, YPY, FY, FA, FR)

(Ta=25°C)

Item	Conditions	Symbol	Characteristics						Unit
				YBG	YPY	FY	FA	FR	
Forward Voltage	I _F =20mA	V _F	TYP.	2.1	2.1	1.9	1.9	1.9	V
			MAX.	2.5	2.5	2.4	2.4	2.4	
Reverse Current	V _R =5V	I _R	MAX.	100	100	100	100	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	565	575	592	609	635	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	562	572	590	605	626	nm
Spectral Line Half Width	I _F =20mA	Δλ	TYP.	15	15	15	15	15	nm
Half Intensity Angle	I _F =20mA	2θ 1/2	TYP.	40	50	50	50	50	deg.

Luminous Intensity Rank

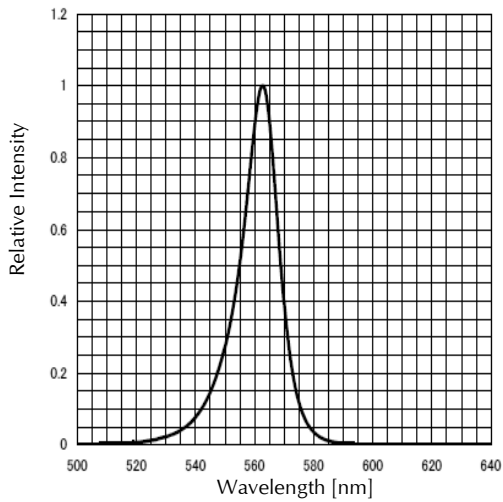
(Ta=25°C)

Rank	I _v (mcd)									
	YBG		YPY		FY		FA		FR	
	I _F =20mA		I _F =20mA		I _F =20mA		I _F =20mA		I _F =20mA	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A	25	50	80	160	70	140	70	140	70	140
B	35	70	110	220	100	200	100	200	100	200
C	50	100	160	320	140	280	140	280	140	280
D	70	140	220	440	200	400	200	400	200	400
E	100	200	320	640	280	-	280	-	280	-
F	200	-	440	-						

※ Please contact our sales staff concerning rank designation.

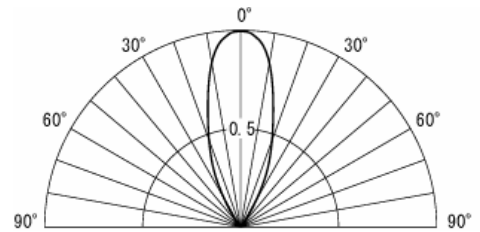
Technical Data(YBG)

Spectral Distribution
Relative Intensity vs. Wavelength
Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$

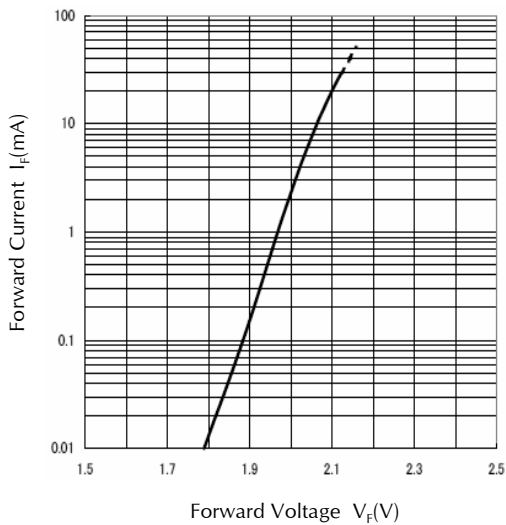


Spatial Distribution Example

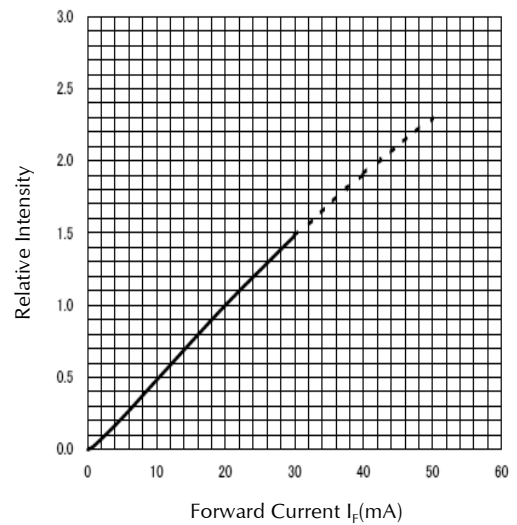
Condition : $T_a = 25^\circ\text{C}$



Forward Voltage vs. Forward Current
Condition : $T_a = 25^\circ\text{C}$



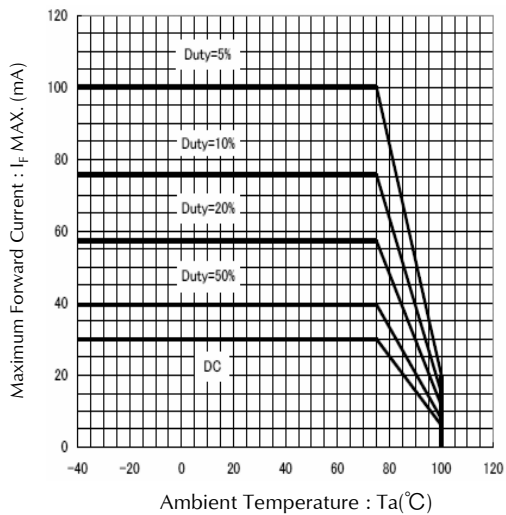
Forward Current vs. Relative Intensity
Condition : $T_a = 25^\circ\text{C}$



Technical Data(YBG)

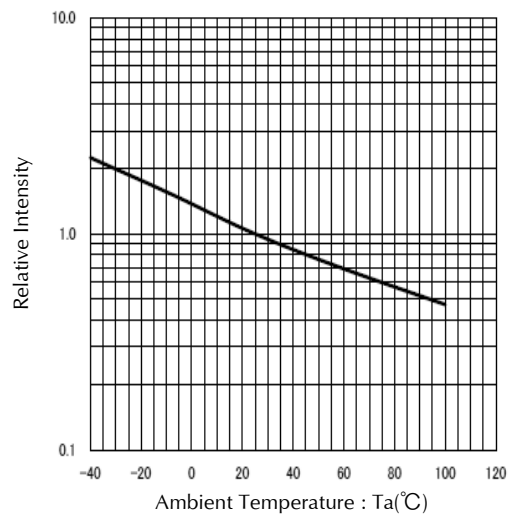
Derating

Ambient Temperature vs. Maximum Forward Current
Repetition Frequency : $f \geq 50\text{Hz}$

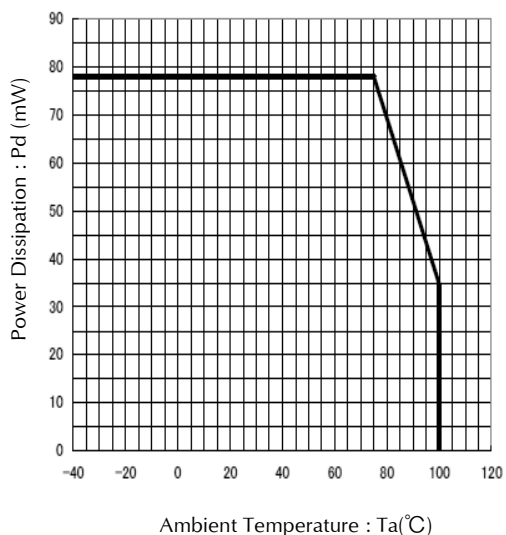


Ambient Temperature vs. Relative Intensity

Condition : $I_F=20\text{mA}$

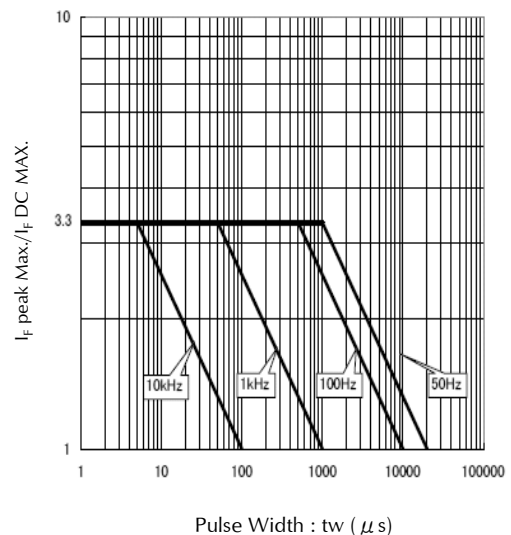


Power Dissipation vs. Ambient Temperature



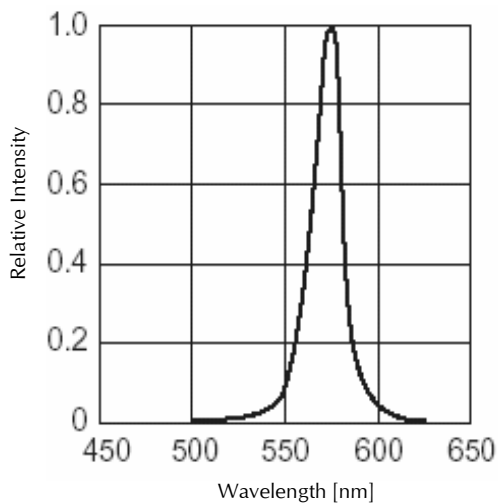
Pulse Width vs. Maximum Tolerable Peak Current

Condition : $T_a = 25^{\circ}\text{C}$



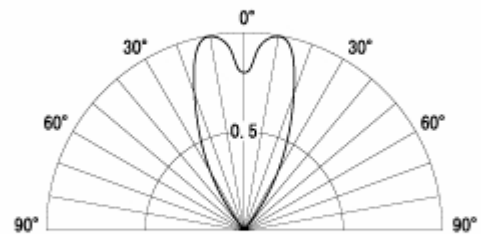
Technical Data(YPY)

Spectral Distribution
Relative Intensity vs. Wavelength
Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$

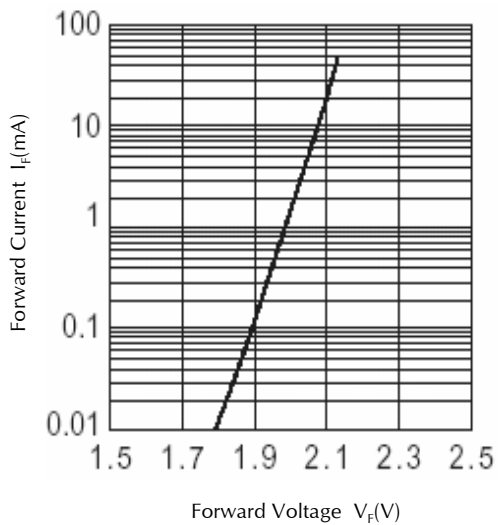


Spatial Distribution Example

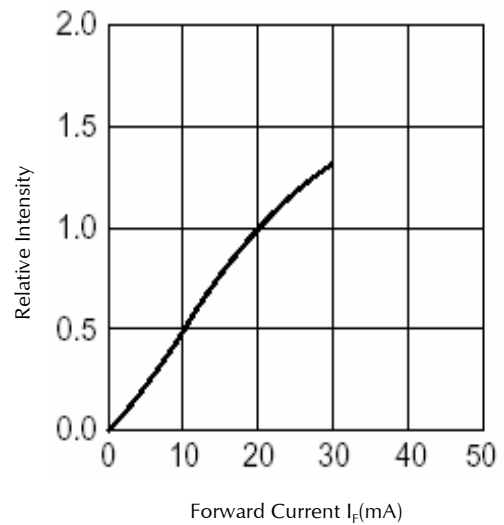
Condition : $T_a = 25^\circ\text{C}$



Forward Voltage vs. Forward Current
Condition : $T_a = 25^\circ\text{C}$



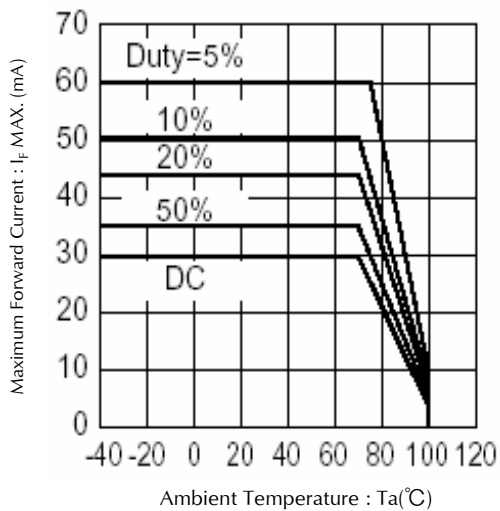
Forward Current vs. Relative Intensity
Condition : $T_a = 25^\circ\text{C}$



Technical Data(YPY)

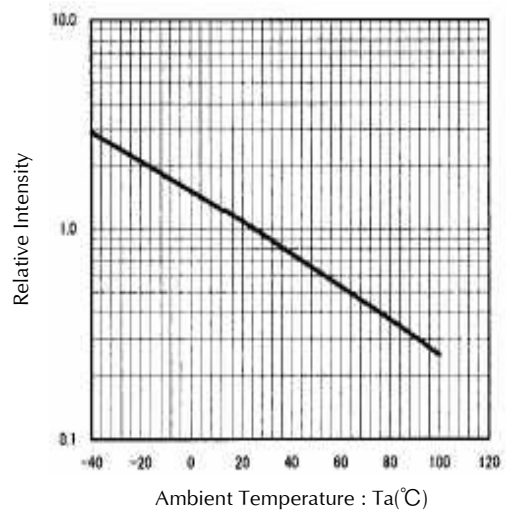
Derating

Ambient Temperature vs. Maximum Forward Current
Repetition Frequency : $f \geq 50\text{Hz}$

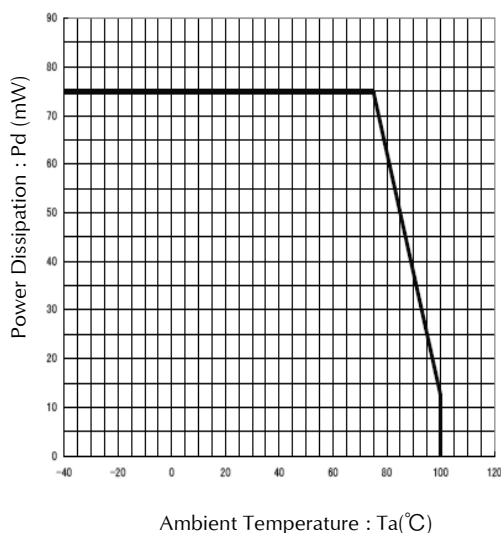


Ambient Temperature vs. Relative Intensity

Condition : $I_F=20\text{mA}$

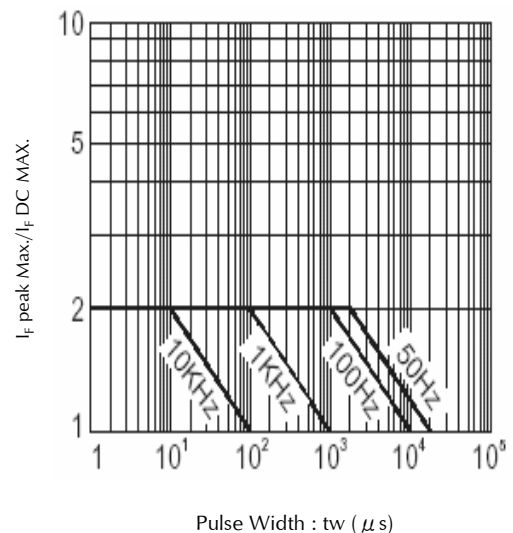


Power Dissipation vs. Ambient Temperature



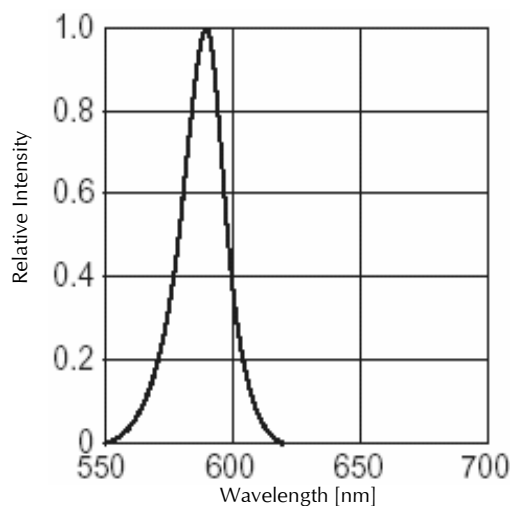
Pulse Width vs. Maximum Tolerable Peak Current

Condition : $T_a = 25^{\circ}\text{C}$



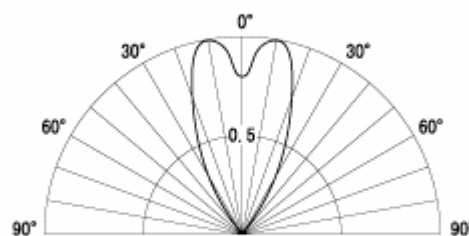
Technical Data(FY)

Spectral Distribution
Relative Intensity vs. Wavelength
Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$

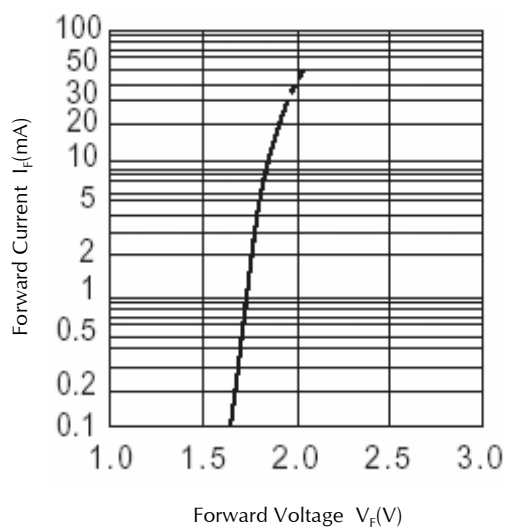


Spatial Distribution Example

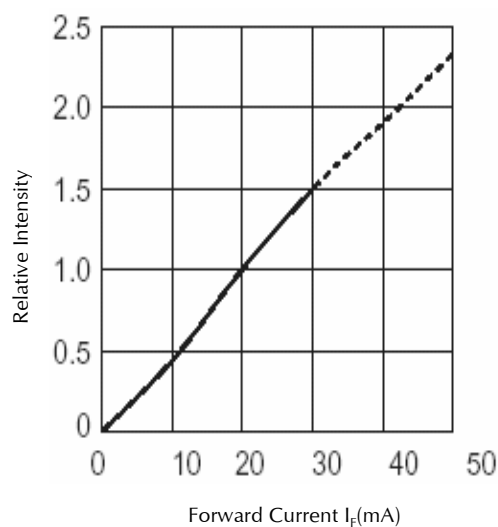
Condition : $T_a = 25^\circ\text{C}$



Forward Voltage vs. Forward Current
Condition : $T_a = 25^\circ\text{C}$



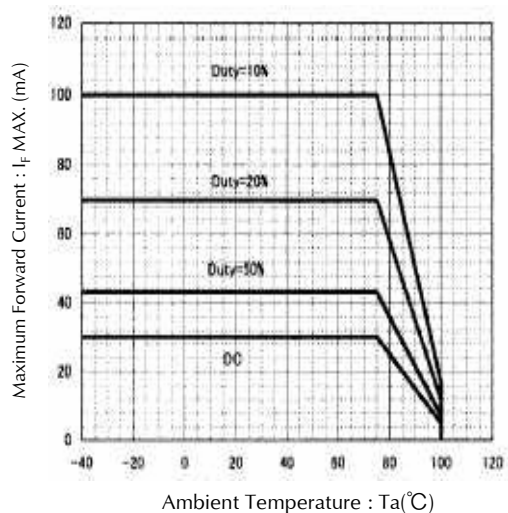
Forward Current vs. Relative Intensity
Condition : $T_a = 25^\circ\text{C}$



Technical Data(FY)

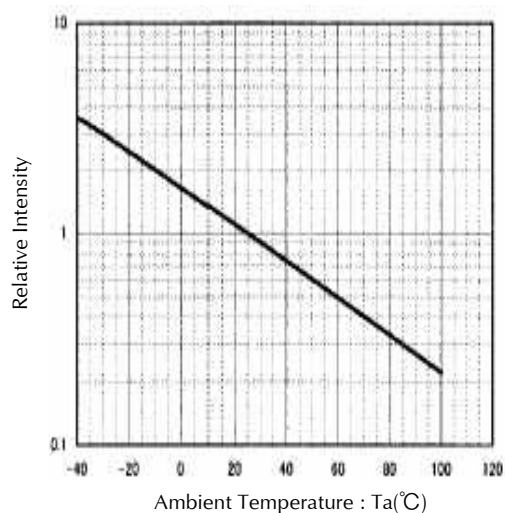
Derating

Ambient Temperature vs. Maximum Forward Current
Repetition Frequency : $f \geq 50\text{Hz}$

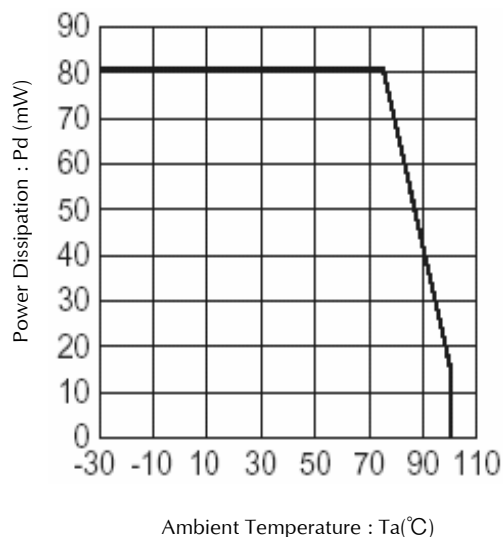


Ambient Temperature vs. Relative Intensity

Condition : $I_F=20\text{mA}$

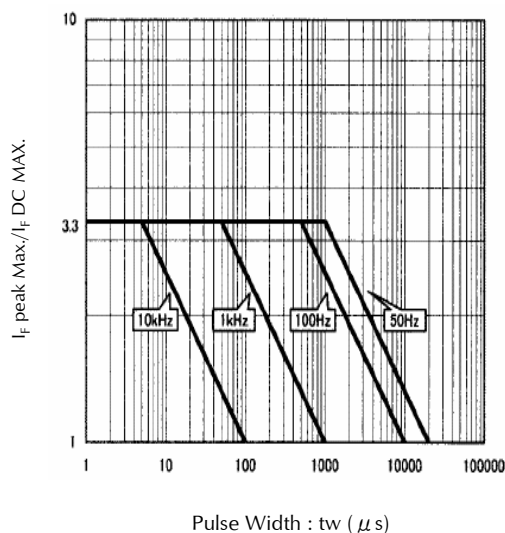


Power Dissipation vs. Ambient Temperature



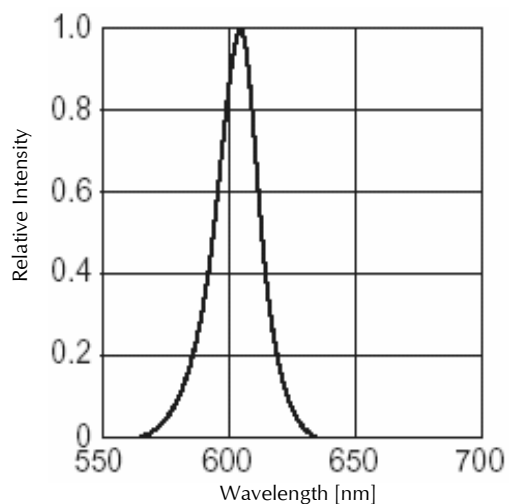
Pulse Width vs. Maximum Tolerable Peak Current

Condition : $T_a = 25^{\circ}\text{C}$



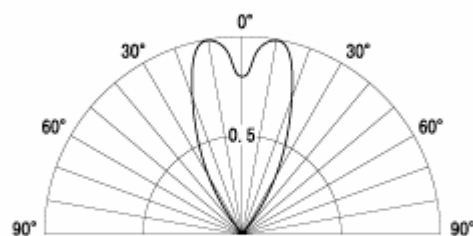
Technical Data(FA)

Spectral Distribution
Relative Intensity vs. Wavelength
Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$

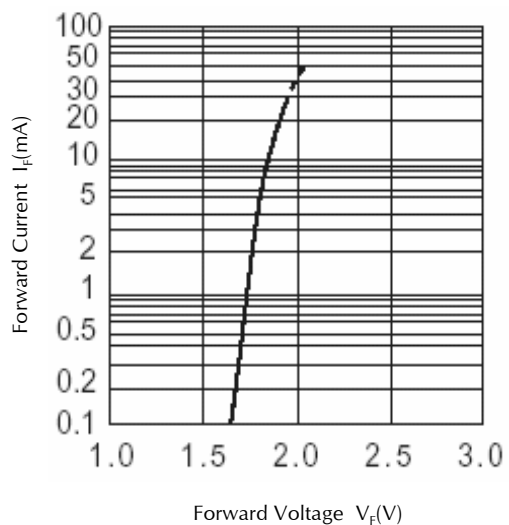


Spatial Distribution Example

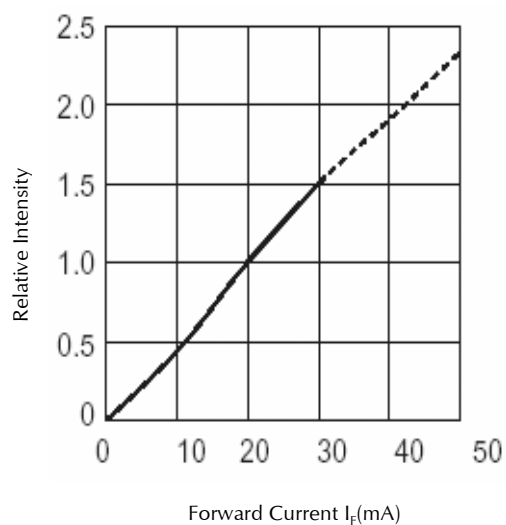
Condition : $T_a = 25^\circ\text{C}$



Forward Voltage vs. Forward Current
Condition : $T_a = 25^\circ\text{C}$



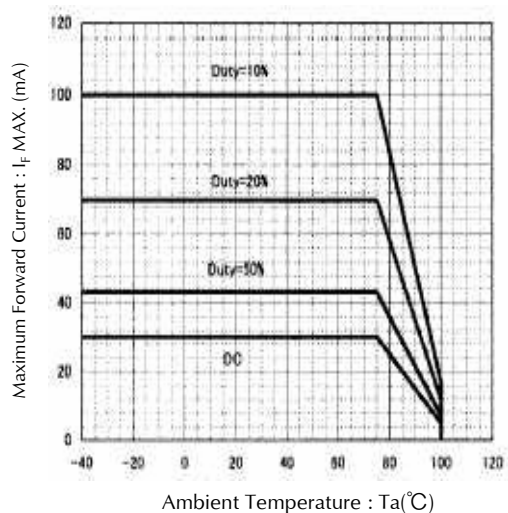
Forward Current vs. Relative Intensity
Condition : $T_a = 25^\circ\text{C}$



Technical Data(FA)

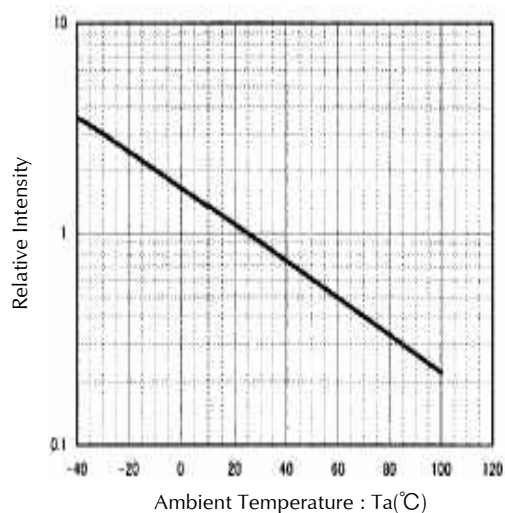
Derating

Ambient Temperature vs. Maximum Forward Current
Repetition Frequency : $f \geq 50\text{Hz}$

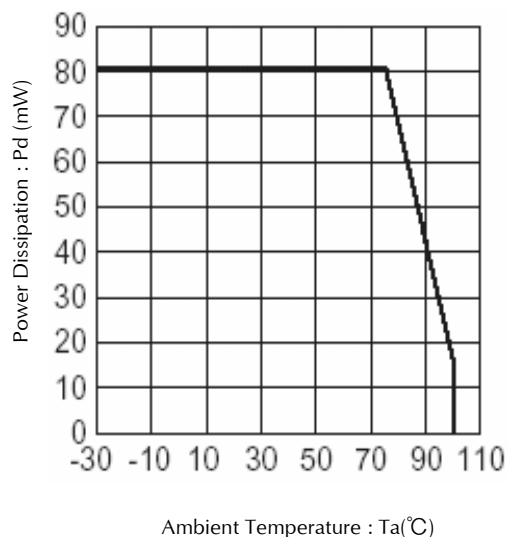


Ambient Temperature vs. Relative Intensity

Condition : $I_F=20\text{mA}$

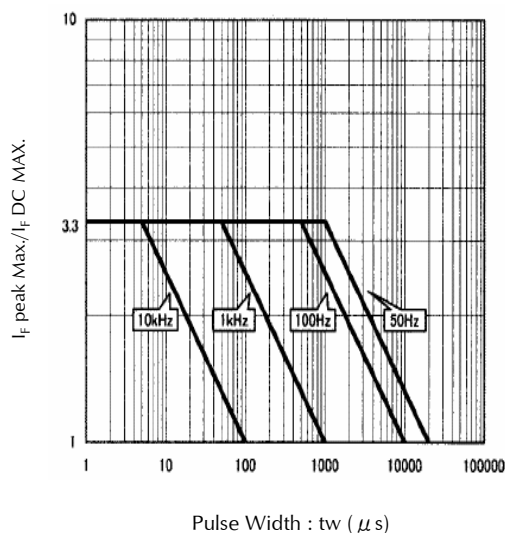


Power Dissipation vs. Ambient Temperature



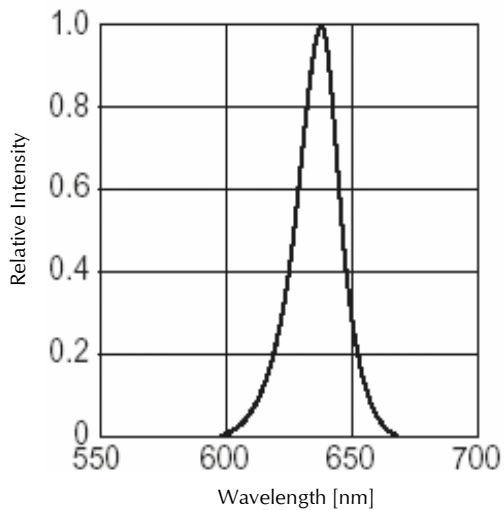
Pulse Width vs. Maximum Tolerable Peak Current

Condition : $T_a = 25^{\circ}\text{C}$



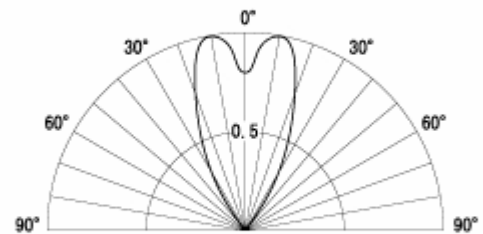
Technical Data(FR)

Spectral Distribution
Relative Intensity vs. Wavelength
Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$

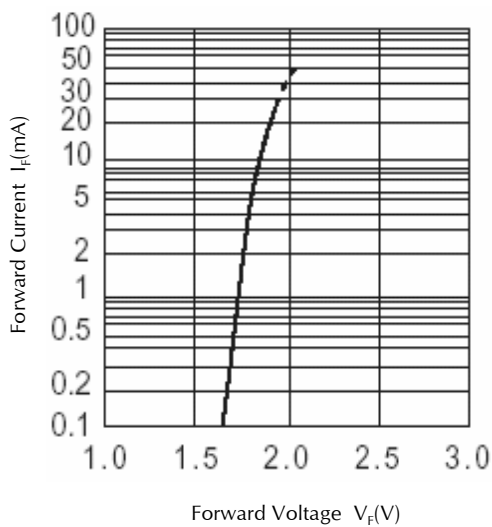


Spatial Distribution Example

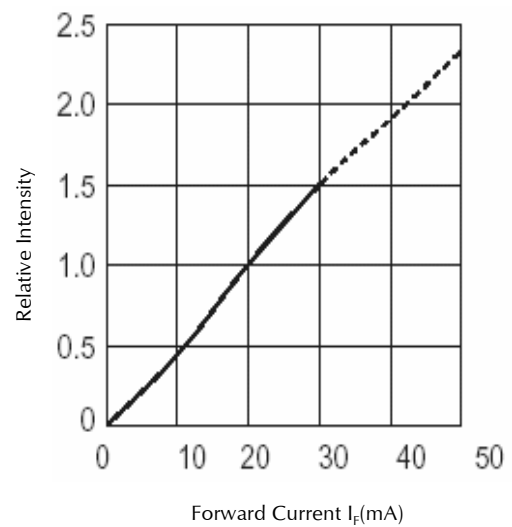
Condition : $T_a = 25^\circ\text{C}$



Forward Voltage vs. Forward Current
Condition : $T_a = 25^\circ\text{C}$



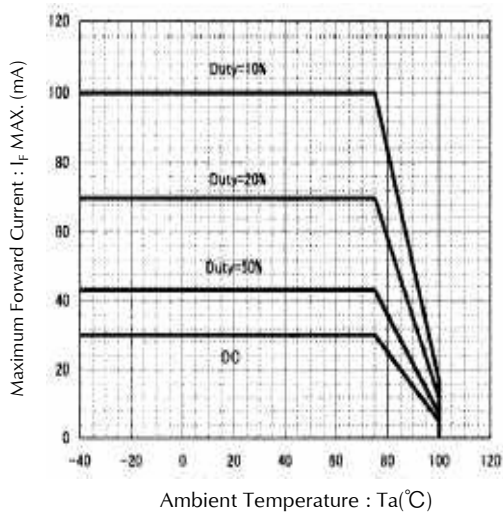
Forward Current vs. Relative Intensity
Condition : $T_a = 25^\circ\text{C}$



Technical Data(FR)

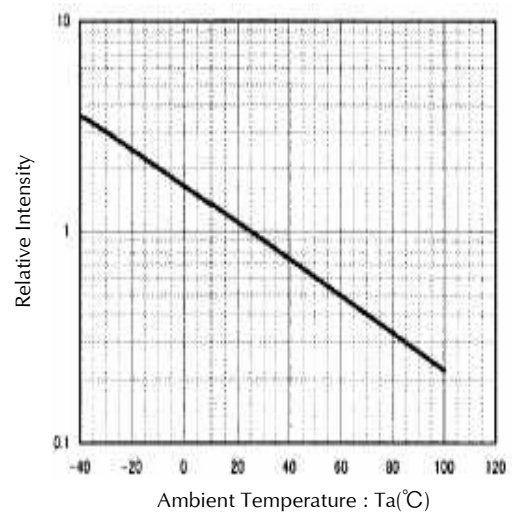
Derating

Ambient Temperature vs. Maximum Forward Current
Repetition Frequency : $f \geq 50\text{Hz}$

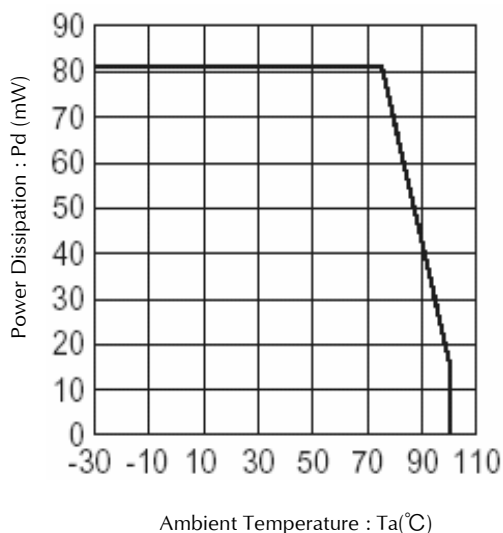


Ambient Temperature vs. Relative Intensity

Condition : $I_F=20\text{mA}$

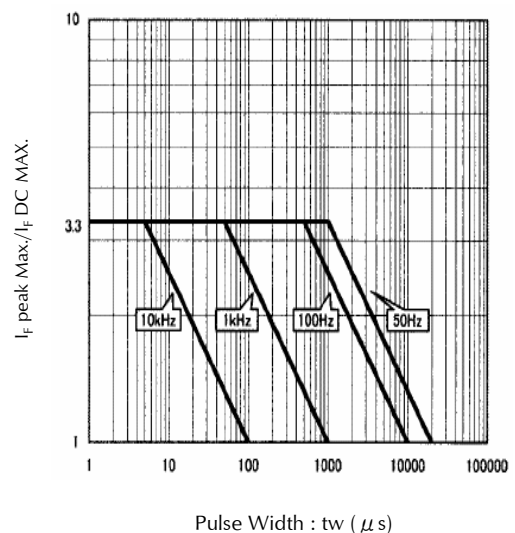


Power Dissipation vs. Ambient Temperature



Pulse Width vs. Maximum Tolerable Peak Current

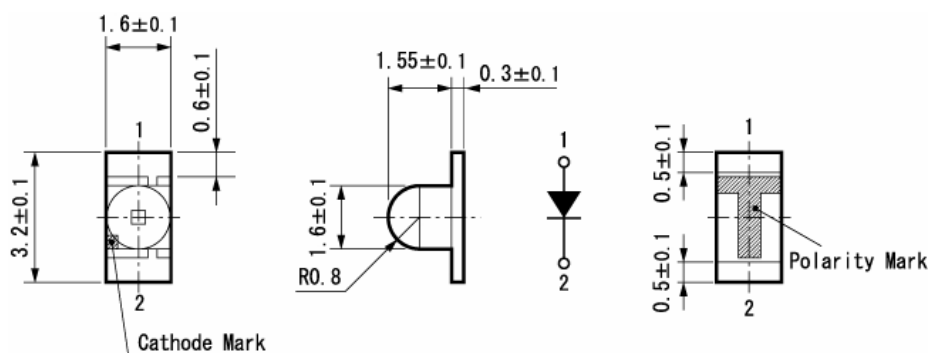
Condition : $T_a = 25^{\circ}\text{C}$



Package Dimensions

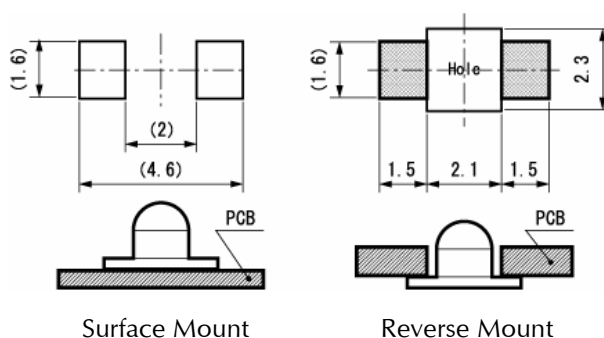
(Unit: mm)

Weight: (7.81)mg



Recommended Soldering Pattern

(Unit: mm)

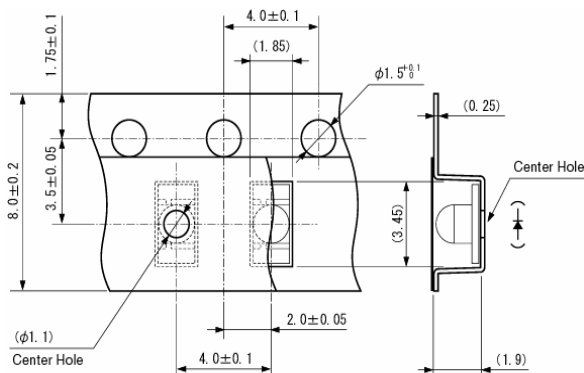


Taping Specification

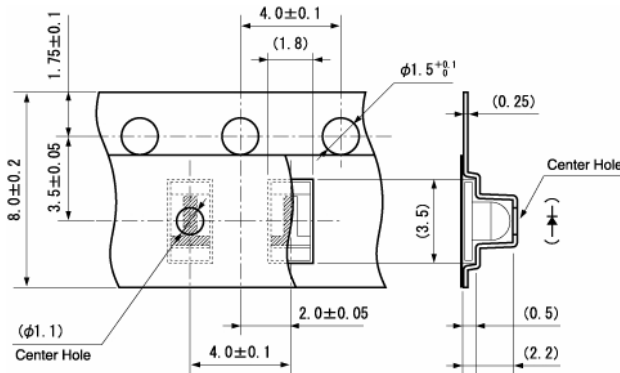
(Unit: mm)

Quantity : 2,000pcs/ reel (standard)

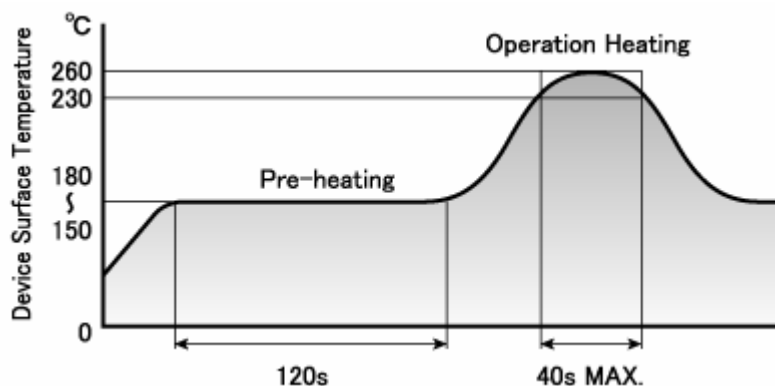
1105W-TR (Surface Mount)



1105W-RR (Reverse Mount)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

Manual Soldering Conditions

Iron tip temp. 350 °C (MAX.)

Soldering time and frequency 3 s (MAX.)
1 time (MAX.)

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, I _F = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(301)	Pre-heating : 150~180°C 120s Max. Operation Heating : 230°C 40s Max. Peak Temperature : 260°C	Twice	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~ Normal Temperature(15min) ~ Maximum Rated Storage Temperature(30min) ~ Normal Temperature(15min)	200 cycles	0/25
High Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 100°C, I _F = 5mA	1,000 h	0/25
Humidity Temp. Operating Life	EIAJ ED-4701/100(102)	Ta = 60±2°C, RH = 90±5%, I _F = 30mA	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	I _V	I _F Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	I _F Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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- 1) The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.
- 2) For the purpose of product improvement, the specifications, characteristics and technical data described in the data sheets are subject to change without prior notice. Therefore it is recommended that the most updated specifications be used in your design.
- 3) When using the products described in the data sheets, please adhere to the maximum ratings for operating voltage, heat dissipation characteristics, and other precautions for use. We are not responsible for any damage which may occur if these specifications are exceeded.
- 4) The products that have been described to this catalog are manufactured so that they will be used for the electrical instrument of the benchmark (OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument).
The application of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. needs a high reliability and safety, and the breakdown and the wrong operation might influence the life or the human body. Please consult us beforehand if you plan to use our product for the usages of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. except OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument.
- 5) In order to export the products or technologies described in this data sheet which are under the "Foreign Exchange and Foreign Trade Control Law," it is necessary to first obtain an export permit from the Japanese government.
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<http://www.stanley-components.com>